



smthybridpackaging

Viscom: Hall 4A, Stand No. 122

Dear Mr. Nordman,

We are pleased to invite you to visit our stand at **SMT 2017** in Nuremberg, from May 16 to 18, 2017. Experience the premiere of the X7056-II and the extremely fast and reliable 3D-AOI S3088 *ultra gold*, with the true-to-life Viscom 360View.

The entire world of inspection technology – for you at SMT:

Sensational speed

3D AXI for the highest demands – Viscom X7056-II



- Outstanding inspection depth
- Excellent image quality
- Highest throughput
- Versatile 3D solution

High speed and the highest reliability

3D AOI without limits – Viscom S3088 *ultra gold*



- 360View for true-to-life, exact 3D all-around view
- XMplus camera module – pure performance in inspection depth and speed
- FastFlow Handling for further increased throughput

And more:

- 3D AOI with XM technology and double track operation – Viscom S6056
- High-power 3D solder paste inspection – Viscom S3088 SPI
- Precise conformal coating inspection – Viscom S3088 CCI
- Highly accurate wire bond inspection – Viscom S6053BO-V

- Manual **X-ray inspection** for SMT/electronics – **Viscom X8011-II PCB**
- Excellent **service** – We offer you advice about **modernization, service** and **support** at our stand

In addition to the newest generation of inspection systems, a drawing with many attractive prizes is waiting for you.

Visit us at the Viscom stand

We will take time for you and your inspection tasks and introduce the newest features and systems to you – and would gladly arrange a fixed appointment. Just describe your topic and send your preferred appointment time to smt17@viscom.de.

We look forward to seeing you!

Volker Pape
Executive Board
Viscom AG



Torsten Pelzer
Vice President Sales
Viscom AG



Link to your guest ticket and registration information:
<https://intfilestation.viscom.de/sharing/cKSxHaaVx>